INTEGRATED CIRCUITS

DATA SHEET



74ALVCH16825 18-bit buffer/driver (3-State)

Product specification

1998 Jul 27

IC24 Data Handbook





18-bit buffer/driver (3-State)

74ALVCH16825

FEATURES

- Wide supply voltage range of 1.2V to 3.6V
- Complies with JEDEC standard no. 8-1A.
- CMOS low power consumption
- Direct interface with TTL levels
- Current drive ± 24 mA at 3.0 V
- MULTIBYTETM flow-through standard pin-out architecture
- Low inductance multiple V_{CC} and GND pins for minimum noise and ground bounce
- All data inputs have bus hold
- Output drive capability 50Ω transmission lines @ 85°C

DESCRIPTION

The 74ALVCH16825 is an 18—bit non-inverting buffer/driver with 3-State outputs for bus-oriented applications.

The 74ALVCH16825 consists of two 9-bit sections with separate output enable signals. For either 9-bit buffer section, the two output enable (10E1 and 10E2 or 20E1 and 20E2) inputs must both be LOW for corresponding D outputs to be active. If either output enable input is HIGH, the outputs of that 9-buffer section are in the high impedance state.

The 74ALVCH16825 has active bus hold circuitry which is provided to hold unused or floating data inputs at a valid logic level. This feature eliminates the need for external pull-up or pull-down resistors.

PIN CONFIGURATION



QUICK REFERENCE DATA

GND = 0V; $T_{amb} = 25^{\circ}C$; $t_r = t_f \le 2.5$ ns

SYMBOL	PARAMETER	CONDITION	TYPICAL	UNIT		
t _{PHL} /t _{PLH}	Propagation delay CP to Qn	$V_{CC} = 2.5V, C_L = 30pF$ $V_{CC} = 3.3V, C_L = 50pF$		2.0 2.0	ns	
C _I	Input capacitance			4.0	pF	
C _{PD}	Power dissipation capacitance per latch	$V_1 = GND \text{ to } V_{CC}^1$	Output enabled	19	pF	
L CAD	ower dissipation capacitance per laten	V = 914D to VCC	Output disabled	3	ρľ	

NOTES:

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μ W): $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o) \text{ where: } f_i = \text{input frequency in MHz; } C_L = \text{output load capacitance in pF; } f_0 = \text{output frequency in MHz; } V_{CC} = \text{supply voltage in V; } \Sigma (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DRAWING NUMBER
56-Pin Plastic Thin Shrink Small Outline (TSSOP) Type II	–40°C to +85°C	74ALVCH16825 DGG	ACH16825 DGG	SOT364-1

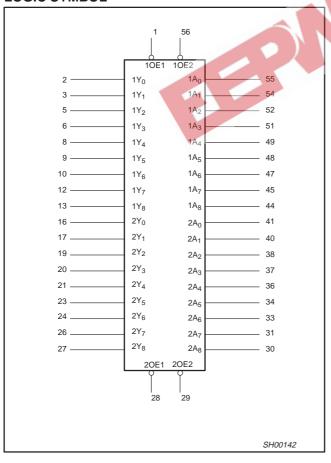
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PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1	1 OE 1	Output enable input
56	1 OE 2	(active LOW)
55, 54, 52, 51, 49, 48, 47, 45, 44	1A0 to 1A8	Data inputs
2, 3, 5, 6, 8, 9, 10, 12, 13	1Y0 to 1Y8	Data outputs
4, 11, 14, 15, 18, 25, 32, 39, 42, 43, 46, 53	GND	Ground (0V)
7, 22, 35, 50	V _{CC}	Positive supply voltage
28	2 OE 1	Output enable input
29	2 OE 2	(active LOW)
43, 42, 41, 40, 38, 37, 36, 34, 33, 31	2A0 to 2A8	Data inputs
16, 17, 19, 20, 21, 23, 24, 26, 27	2Y0 to 2Y8	Data outputs

LOGIC SYMBOL



FUNCTION TABLE

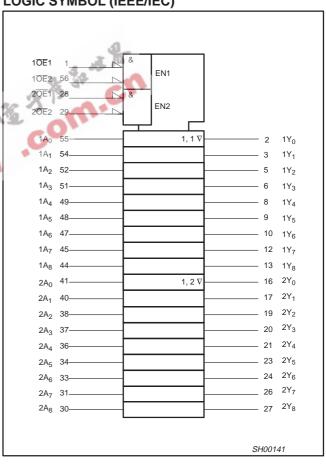
	INPUTS										
nOE1	nOE1 nOE2 A										
L	L	L	L								
L	L	Н	Н								
Н	Х	Х	Z								
X	Н	X	Z								

HIGH voltage level LOW voltage level

Don't care

L X Z High impedance "off" state

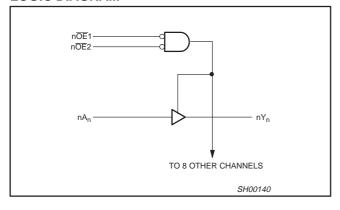
LOGIC SYMBOL (IEEE/IEC)



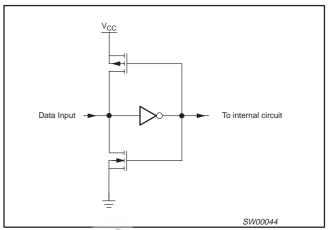
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LOGIC DIAGRAM



BUS HOLD CIRCUIT



RECOMMENDED OPERATING CONDITIONS

		10.0			
SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
V	DC supply voltage 2.5V range (for max. speed performance @ 30 pF output load)	4 3 m	2.3	2.7	V
V _{CC}	DC supply voltage 3.3V range (for max. speed performance @ 50 pF output load)	.60	3.0	3.6	V
VI	DC Input voltage range		0	V _{CC}	V
V _O	DC output voltage range		0	V _{CC}	V
T _{amb}	Operating free-air temperature range		-40	+85	°C
t _r , t _f	Input rise and fall times	$V_{CC} = 2.3 \text{ to } 3.0 \text{V}$ $V_{CC} = 3.0 \text{ to } 3.6 \text{V}$	0	20 10	ns/V

ABSOLUTE MAXIMUM RATINGS

In accordance with the Absolute Maximum Rating System (IEC 134) Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +4.6	V
I _{IK}	DC input diode current	V ₁ < 0	- 50	mA
V	DC input voltage	For control pins ²	-0.5 to +4.6	V
V _I	DC input voltage	For data inputs ²	-0.5 to V _{CC} +0.5	V
I _{OK}	DC output diode current	$V_{O} > V_{CC}$ or $V_{O} < 0$	±50	mA
Vo	DC output voltage	Note 2	-0.5 to V _{CC} +0.5	V
Io	DC output source or sink current	$V_{O} = 0$ to V_{CC}	±50	mA
I _{GND} , I _{CC}	DC V _{CC} or GND current		± 100	mA
T _{stg}	Storage temperature range		-65 to +150	°C
P _{TOT}	Power dissipation per package -plastic medium-shrink (SSOP) -plastic thin-medium-shrink (TSSOP)	For temperature range: -40 to +125 °C above +55°C derate linearly with 11.3 mW/K above +55°C derate linearly with 8 mW/K	850 600	mW

NOTE:

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^{1.} Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

^{2.} The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltage are referenced to GND (ground = 0 V).

				LIMITS		
SYMBOL	PARAMETER	TEST CONDITIONS	Temp :	דואט		
			MIN	TYP ¹	MAX	1
	LIIOLLI I I I I	V _{CC} = 2.3 to 2.7V	1.7	1.2		,,
V_{IH}	HIGH level Input voltage	V _{CC} = 2.7 to 3.6V	2.0	1.5		\ \
.,	LOW book book on the ma	V _{CC} = 2.3 to 2.7V		1.2	0.7	V
V_{IL}	LOW level Input voltage	V _{CC} = 2.7 to 3.6V		1.5	0.8	1 '
		V_{CC} = 2.3 to 3.6V; V_I = V_{IH} or V_{IL} ; I_O = $-100\mu A$	V _{CC} -0.2	V _{CC}		
		$V_{CC} = 2.3V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -6mA$	V _{CC} _0.3	V _{CC} -0.08		1
	LIIOLLI saad sadaad aabtaa	$V_{CC} = 2.3V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -12mA$	V _{CC} - 0.6	V _{CC} - 0.26		1 ,
V _{OH}	HIGH level output voltage	$V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL}; I_O = -12\text{mA}$	V _{CC} − 0.5	V _{CC} _0.14		\ V
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -12mA$	V _{CC} -0.6	V _{CC} - 0.09		1
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = -24\text{mA}$	V _{CC} - 1.0	V _{CC} - 0.28		1
		$V_{CC} = 2.3 \text{ to } 3.6 \text{V}; \ V_{I} = V_{IH} \text{ or } V_{IL}; \ I_{O} = 100 \mu \text{A}$		GND	0.20	٧
		$V_{CC} = 2.3V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 6mA$		0.07	0.40	V
V_{OL}	LOW level output voltage	$V_{CC} = 2.3V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 12mA$		0.15	0.70	
		$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 12mA$		0.14	0.40	V
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 24$ mA		0.27	0.55	1
II	Input leakage current	$V_{CC} = 2.3 \text{ to } 3.6\text{V};$ $V_{I} = V_{CC} \text{ or GND}$		0.1	5	μА
I _{OZ}	3-State output OFF-state current	V_{CC} = 2.3 to 3.6V; V_I = V_{IH} or V_{IL} ; V_O = V_{CC} or GND		0.1	10	μА
I _{CC}	Quiescent supply current	V_{CC} = 2.3 to 3.6V; V_I = V_{CC} or GND; I_O = 0		0.2	40	μΑ
Δl _{CC}	Additional quiescent supply current	$V_{CC} = 2.3V \text{ to } 3.6V; V_I = V_{CC} - 0.6V; I_O = 0$		150	750	μΑ
I _{BHL} ²	Bus hold LOW sustaining current	$V_{CC} = 2.3V; V_I = 0.7V$	45	_		μА
.RHT	Sub-field E-011 Subtaining Sufferin	$V_{CC} = 3.0V; V_I = 0.8V$	75	150		μΛ
I _{BHH} ²	Bus hold HIGH sustaining current	$V_{CC} = 2.3V; V_I = 1.7V$	-45			μΑ
	Ŭ	$V_{CC} = 3.0V; V_I = 2.0V$	- 75	-175		Ľ
I _{BHLO} ²	Bus hold LOW overdrive current	V _{CC} = 3.6V	500			μΑ
I _{BHHO} ²	Bus hold HIGH overdrive current	V _{CC} = 3.6V	-500			μΑ

NOTES:

All typical values are at T_{amb} = 25°C.
 Valid for data inputs of bus hold parts.

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AC CHARACTERISTICS FOR $V_{CC} = 2.3V$ TO 2.7V RANGE

GND = 0V; $t_r = t_f \le 2.0 \text{ns}$; $C_L = 30 \text{pF}$

SYMBOL	PARAMETER	WAVEFORM	V _C	UNIT		
			MIN	TYP ¹	MAX	
t _{PHL} /t _{PLH}	Propagation delay nAn to nYn	1, 3	1.0	2.0	4.1	ns
t _{PZH} /t _{PZL}	3-State output enable time nOEn to nYn	2, 3	1.0	2.9	6.0	ns
t _{PHZ} /t _{PLZ}	3-State output disable time nOEn to nYn	2,3	1.2	2.2	5.6	ns

NOTE:

AC CHARACTERISTICS FOR V_{CC} = 3.0V TO 3.6V RANGE AND V_{CC} = 2.7V

 $GND = 0V; \ t_r = t_f \leq 2.5 ns; \ C_L = 50 pF$

			LIMITS	- 4					
SYMBOL	PARAMETER	WAVEFORM	٧c	$c = 3.3 \pm 0.$	3V		V _{CC} = 2.7V		UNIT
			MIN	TYP ^{1, 2}	MAX	MIN	TYP ¹	MAX	
t _{PHL} /t _{PLH}	Propagation delay nAn to nYn	1, 3	1.0	2.0	3.4	1.0	2.1	3.9	ns
t _{PZH} /t _{PZL}	3-State output enable time nOEn to nYn	2, 3	1.0	2.8	4.7	1.0	2.9	5.7	ns
t _{PHZ} /t _{PLZ}	3-State output disable time nOEn to nYn	2, 3	1.3	2.9	4.5	1.3	3.0	4.9	ns

NOTES:

- All typical values are measured T_{amb} = 25°C
- 2. Typical value is measured at $V_{CC} = 3.3V$

AC WAVEFORMS FOR $V_{CC} = 2.3V$ TO 2.7V AND V_{CC} < 2.3V RANGE

 $V_M = 0.5 V_{CC}$

 $V_X = V_{OL} + 0.15V$

 $V_{Y} = V_{OH} - 0.15V$

 V_{OL} and V_{OH} are the typical output voltage drop that occur with the

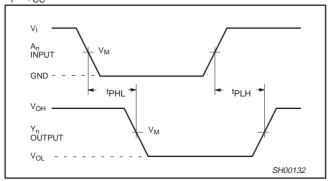
AC WAVEFORMS FOR $V_{CC} = 3.0V$ TO 3.6V AND $V_{CC} = 2.7V RANGE$

 $V_{M} = 1.5 \text{ V}$ $V_{X} = V_{OL} + 0.3 \text{V}$ $V_{Y} = V_{OH} - 0.3 \text{V}$

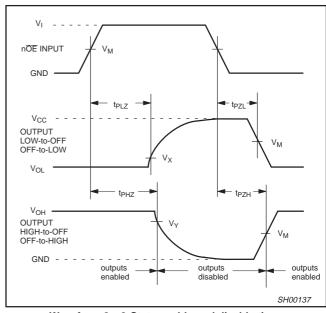
VOL and VOH are the typical output voltage drop that occur with the output load.

 $V_1 = 2.7V$

 $V_{I} = V_{CC}$



Waveform 1. Input (Dn) to output (Yn) propagation delay



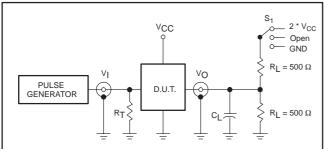
Waveform 2. 3-State enable and disable times

^{1.} All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.

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TEST CIRCUIT



Test Circuit for switching times

DEFINITIONS

R_L = Load resistor

C_L = Load capacitance includes jig and probe capacitance

 R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.

SWITCH POSITION

TEST	S ₁
t _{PLH} /t _{PHL}	Open
t _{PLZ} /t _{PZL}	2 * V _{CC}
t _{PHZ} /t _{PZH}	GND

Vcc	VI
< 2.7V	Vcc
2.7-3.6V	2.7V

SV00906

Waveform 3. Load circuitry for switching times

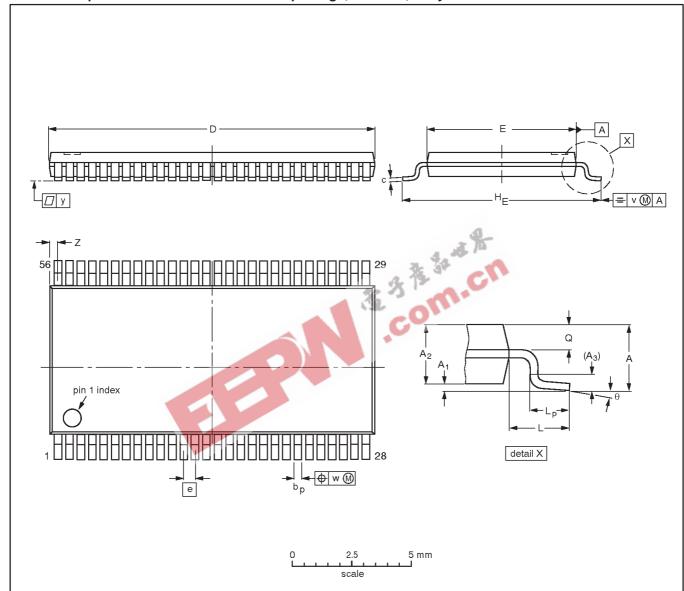


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TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1mm

SOT364-1



DIMENSIONS (mm are the original dimensions).

UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	٧	w	у	Z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	14.1 13.9	6.2 6.0	0.5	8.3 7.9	1.0	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.5 0.1	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES					EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ			PROJECTION	ISSUE DATE
SOT364-1		MO-153EE					-93-02-03 95-02-10

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NOTES



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Data sheet status

Data sheet status	Product status	Definition [1]	
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.	
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.	
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.	

^[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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